

RoHS

COMPLIANT HALOGEN

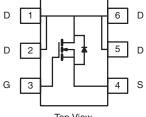
FREE Available

**Vishay Siliconix** 

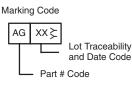
## N-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (</b> Ω <b>)</b>	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)	
	0.049 at V <sub>GS</sub> = 4.5 V	6.1 <sup>a</sup>		
20	0.056 at V <sub>GS</sub> = 2.5 V	5.7	6.0	
	0.065 at V <sub>GS</sub> = 1.8 V	5.3		





Top View

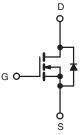


#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 %  $\rm R_{g}$  and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

• Load Switch for Portable Devices



N-Channel MOSFET

Ordering Information: Si1488DH-T1-E3 (Lead (Pb)-free) Si1488DH-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	20	V	
Gate-Source Voltage		V <sub>GS</sub>	± 8	V	
	T <sub>C</sub> = 25 °C		6.1		
Continuous Droin Current /T 150 °C)ª	T <sub>C</sub> = 70 °C		4.9		
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 25 °C	I <sub>D</sub>	4.6 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		3.7 <sup>b, c</sup>	— A	
Pulsed Drain Current		I <sub>DM</sub>	20		
Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	10		
Repetitive Avalanche Energy		E <sub>AS</sub>	5	mJ	
Continuous Courses Drain Diada Current	T <sub>C</sub> = 25 °C		2.3		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	1.3 <sup>b, c</sup>	— A	
	T <sub>C</sub> = 25 °C		2.8		
Maximum Power Dissipation <sup>a</sup>	T <sub>C</sub> = 70 °C		1.8		
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	1.5 <sup>b, c</sup>	W	
	T <sub>A</sub> = 70 °C		1.0 <sup>b, c</sup>		
Operating Junction and Storage Temperature R	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 5 s	R <sub>thJA</sub>	60	80	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	34	45	0/11	

Notes:

a. Based on  $T_C = 25$  °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s. d. Maximum under steady state conditions is 125 °C/W.

# Si1488DH

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	•		•	•	•		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$	20			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L 050 A		20.2		m)//9	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/$	l <sub>D</sub> = 250 μA		- 2.75		mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	0.45		0.95	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 8 V$			± 100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V			1	μA	
		$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 85 ^{\circ}\text{C}$			10	μA	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS}$ = $\geq$ 5 V, $V_{GS}$ = 4.5 V	20			Α	
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 4.6 A		0.041	0.049		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 4.3 \text{ A}$		0.047	0.056	Ω	
		V <sub>GS</sub> = 1.8 V, I <sub>D</sub> = 3.9 A		0.054	0.065		
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 4.6 A		15		mS	
Dynamic <sup>b</sup>	•		•	•	•		
Input Capacitance	C <sub>iss</sub>			530		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz		100			
Reverse Transfer Capacitance	C <sub>rss</sub>			48			
Tabal Qasha Qhanna	Qg	$V_{DS} = 10 \text{ V}, V_{GS} = 5 \text{ V}, I_{D} = 4.6 \text{ A}$		6.6	10	pC	
Total Gate Charge				6	9		
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 4.6 A		1.5			
Gate-Drain Charge	Q <sub>qd</sub>			0.9			
Gate Resistance	R <sub>q</sub>	f = 1 MHz		7.3	11	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			8.5	13		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 10 V, R <sub>L</sub> = 2.7 $\Omega$		45	68	- ns	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong 3.7 \text{ A}, V_{\text{GEN}} = 4.5 \text{ V}, R_g = 1 \Omega$		35	53		
Fall Time	t <sub>f</sub>			82	123		
Drain-Source Body Diode Characteristic	cs	· · · · · · · · · · · · · · · · · · ·					
Continous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			2.3	A	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				20		
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 2.2 A		0.8	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			10.6	16	nC	
Body Diode Reverse Recovery Charge Q <sub>rr</sub>				3.7	5.7	1	
Reverse Recovery Fall Time	t <sub>a</sub>	I <sub>F</sub> = 3.2 A, dI/dt = 100 A/μs		6.2		ns	
Reverse Recovery Rise Time	t <sub>b</sub>			4.4			

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

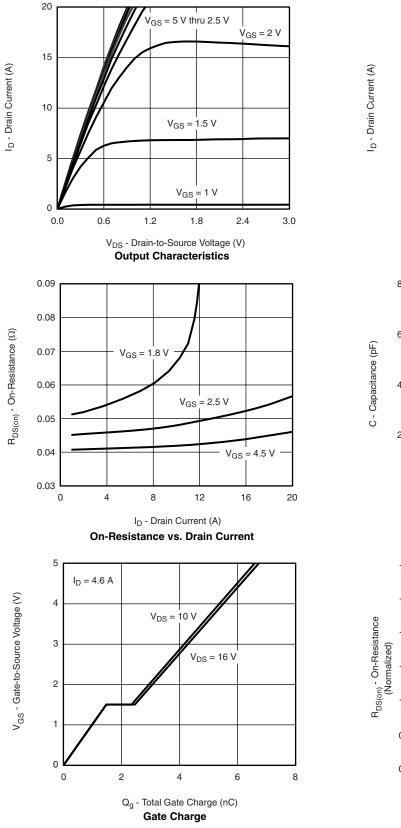
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

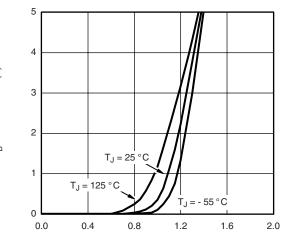


# Si1488DH

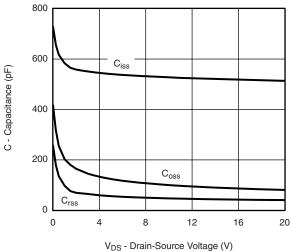
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#### **TYPICAL CHARACTERISTICS** $T_A = 25$ °C, unless otherwise noted

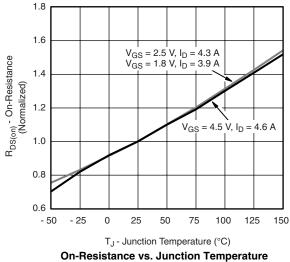




V<sub>GS</sub> - Gate-to-Source Voltage (V) Transfer Characteristics Curves vs. Temperature



Capacitance

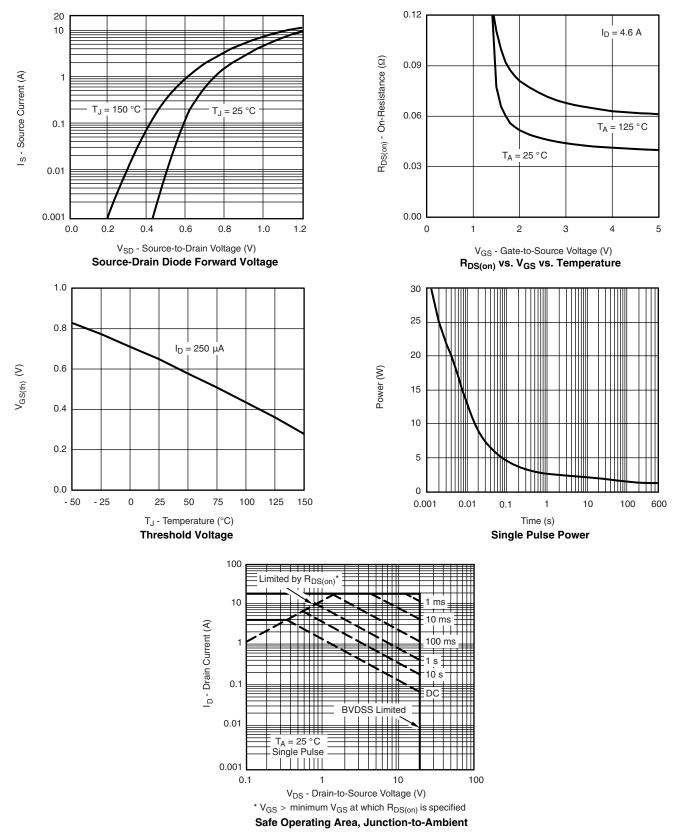


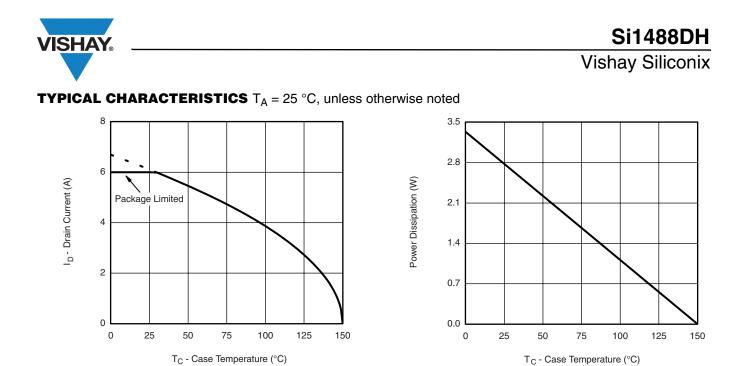
## Si1488DH

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**Current Derating\*** 

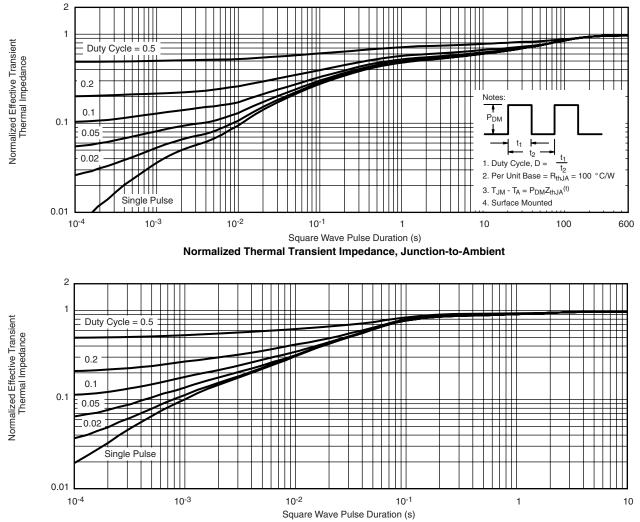
\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

**Power Derating** 

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#### **TYPICAL CHARACTERISTICS** $T_A = 25 \text{ °C}$ , unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?73788">www.vishay.com/ppg?73788</a>.



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